

XC2S100E-6FTG256C

Data Sheet

FPGA Spartan®-IIE F	amily 100K Gates 2700 Cells 357MHz 0.15um Technology 1.8V	* EXILINX* SPARTAN*	* EXILINX* SPARTAN*	• EX
Manufacturers	AMD Xilinx, Inc	17 KC281004 D2196993A 61 TAIWAN	• • • • • • • • • • • • • • • • • • •	SPA XC2S FTG2 D219 61 TAIN
Package/Case	BGA-256	• EXILINX SPARTAN• XC23100E ^{III} FT6250AG10937 D219690AG10937 61 TAIWAN		
Product Type	Programmable Logic ICs	<u> </u>		
RoHS		* Exilinx* Spartan* Xc25100 ^m FT625646f0937	* EXILINX* SPARTAN* XC2S100E ^{IM} FT0256AGT0937	1
Lifecycle		6		
Please submit RFO	for XC2S100E-6FTG256C or <u>Email to us: sales@ovaga.com</u> We will o	contact vou in 12		
		contact you in 12	RFO	

General Description

XC2S100E-6FTG256C is a Field Programmable Gate Array (FPGA) device manufactured by Xilinx, a leading provider of FPGA and programmable logic solutions.

Features

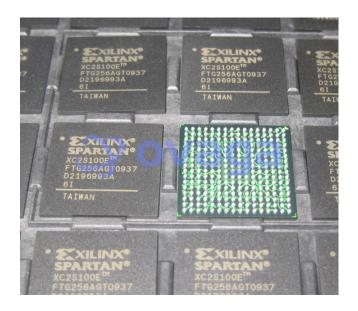
hours.

Application

XC2S100E-6FTG256C has a maximum gate countXC2S100E-6FTG256C can be used in a wide range of applications, including digital signalof 100,000 and is based on a 0.18µm CMOSprocessing, communication, multimedia, aerospace, defense, automotive, and industrialprocess.control.

It has 2.5V to 3.3V power supply voltage, and 256- It is suitable for high-performance and low-power applications, especially those requiring pin Fine-Pitch Ball-Grid Array (FBGA) packaging. high-speed and parallel data processing.

It also features up to 316 user I/Os and up to 92 differential signal pairs.



Related Products



XC18V01S020C AMD Xilinx, Inc SOP-20



AMD Xilinx, Inc TSSOP20

XCF04SV0G20C



XC6SLX4-2CSG225C AMD Xilinx, Inc BGA-225



XCV50-6BG256C

AMD Xilinx, Inc BGA256







AMD Xilinx, Inc TSOP-48

XCF08PV0G48C

XC6SLX25-3FTG256C

AMD Xilinx, Inc BGA-256

XC6SLX16-3CSG324C

AMD Xilinx, Inc BGA-324



XCF32PVO48C

AMD Xilinx, Inc TSOP48